

## TC74HC273AP, TC74HC273AF, TC74HC273AFW

### Octal D-Type Flip Flop with Clear

The TC74HC273A is a high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate CMOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

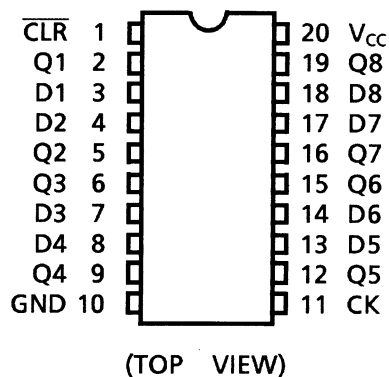
When the CLR input is held "L", the Q outputs are at a low logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

### Features

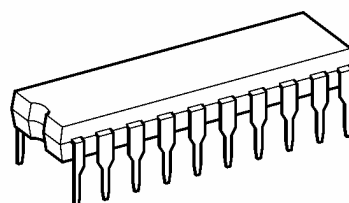
- High speed:  $f_{max} = 67 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu\text{A}$  (max) at  $T_a = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 4 \text{ mA}$  (min)
- Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range:  $V_{CC} (\text{opr}) = 2 \sim 6 \text{ V}$
- Pin and function compatible with 74LS273

### Pin Assignment



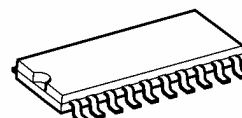
Note: xxxFW (JEDEC SOP) is not available in Japan.

TC74HC273AP

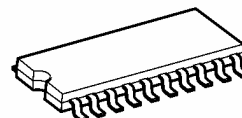


DIP20-P-300-2.54A

TC74HC273AF

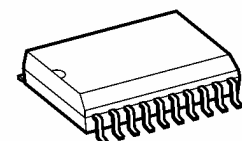


SOP20-P-300-1.27A



SOP20-P-300-1.27

TC74HC273AFW

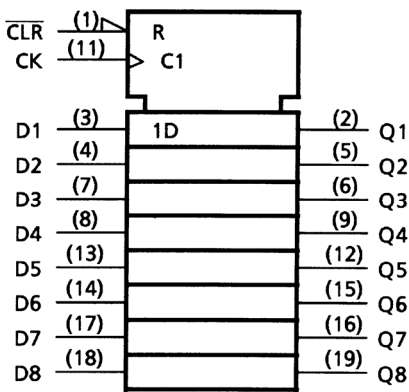


SOL20-P-300-1.27

### Weight

DIP20-P-300-2.54A	: 1.30 g (typ.)
SOP20-P-300-1.27A	: 0.22 g (typ.)
SOP20-P-300-1.27	: 0.22 g (typ.)
SOL20-P-300-1.27	: 0.46 g (typ.)

IEC Logic Symbol

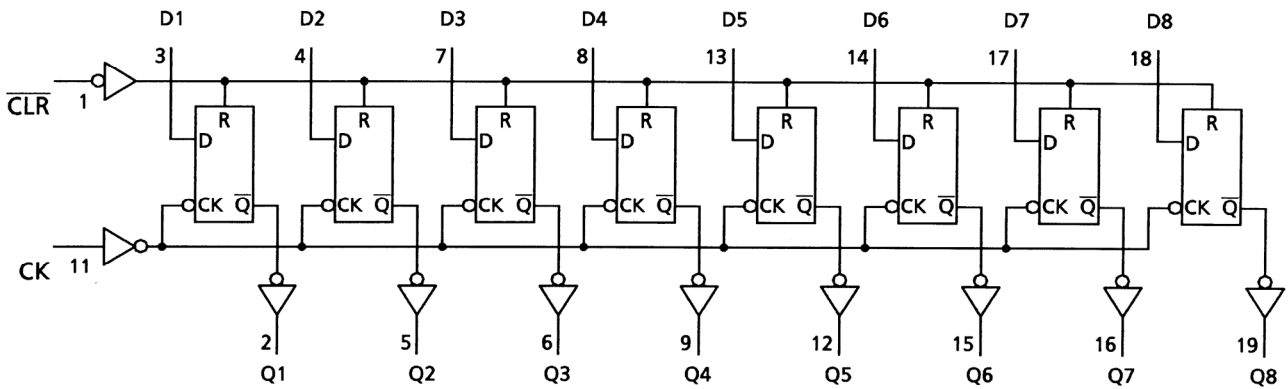


Truth Table

Inputs			Output	Function
CLR	D	CK	Q	
L	X	X	L	Clear
H	L		L	—
H	H		H	—
H	X		Q <sub>n</sub>	No change

X: Don't care

System Diagram



**Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	$-0.5 \sim 7$	V
DC input voltage	$V_{IN}$	$-0.5 \sim V_{CC} + 0.5$	V
DC output voltage	$V_{OUT}$	$-0.5 \sim V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	$\pm 20$	mA
Output diode current	$I_{OK}$	$\pm 20$	mA
DC output current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 50$	mA
Power dissipation	$P_D$	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	$T_{stg}$	$-65 \sim 150$	$^{\circ}\text{C}$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: 500 mW in the range of  $T_a = -40 \sim 65^{\circ}\text{C}$ . From  $T_a = 65$  to  $85^{\circ}\text{C}$  a derating factor of  $-10 \text{ mW}/^{\circ}\text{C}$  shall be applied until 300 mW.

**Recommended Operating Conditions (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2~6	V
Input voltage	$V_{IN}$	$0 \sim V_{CC}$	V
Output voltage	$V_{OUT}$	$0 \sim V_{CC}$	V
Operating temperature	$T_{opr}$	$-40 \sim 85$	$^{\circ}\text{C}$
Input rise and fall time	$t_r, t_f$	0~1000 ( $V_{CC} = 2.0 \text{ V}$ ) 0~500 ( $V_{CC} = 4.5 \text{ V}$ ) 0~400 ( $V_{CC} = 6.0 \text{ V}$ )	ns

Note: The recommended operating conditions are required to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

## Electrical Characteristics

## DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C				Ta = -40~85°C		Unit
				V <sub>CC</sub> (V)	Min	Typ.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	—		2.0 4.5 6.0	1.50 3.15 4.20	— — —	— — —	1.50 3.15 4.20	— — —	V
Low-level input voltage	V <sub>IL</sub>	—		2.0 4.5 6.0	— — —	— — —	0.50 1.35 1.80	— — —	0.50 1.35 1.80	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
			I <sub>OH</sub> = -4 mA I <sub>OH</sub> = -5.2 mA	6.0	5.9	6.0	—	5.9	—	
				4.5	4.18	4.31	—	4.13	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 20 μA	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
			I <sub>OL</sub> = 4 mA I <sub>OL</sub> = 5.2 mA	6.0	—	0.0	0.1	—	0.1	
				4.5	—	0.17	0.26	—	0.33	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	6.0	—	—	±0.1	—	±1.0	μA	
				—	—	4.0	—	40.0	μA	

Timing Requirements (input: t<sub>r</sub> = t<sub>f</sub> = 6 ns)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 ~85°C	Unit	
			VCC (V)	Typ.	Limit		Limit
Minimum pulse width (CK)	tW (L) tW (H)	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum pulse width ( CLR )	tW (L)	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum set-up time	tS	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum hold time	tH	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum removal time ( CLR )	trem	—	2.0	—	50	65	ns
			4.5	—	10	13	
			6.0	—	9	11	
Clock frequency	f	—	2.0	—	6	5	MHz
			4.5	—	30	24	
			6.0	—	35	28	

**AC Characteristics ( $C_L = 15 \text{ pF}$ ,  $V_{CC} = 5 \text{ V}$ ,  $T_a = 25^\circ\text{C}$ , input:  $t_r = t_f = 6 \text{ ns}$ )**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	$t_{TLH}$ $t_{THL}$	—	—	4	8	ns
Propagation delay time (CK-Q)	$t_{pLH}$ $t_{pHL}$	—	—	15	25	ns
Propagation delay time ( $\overline{\text{CLR}}$ -Q)	$t_{pLH}$ $t_{pHL}$	—	—	16	27	ns
Maximum clock frequency	$f_{\text{max}}$	—	40	67	—	MHz

**AC Characteristics ( $C_L = 50 \text{ pF}$ , input:  $t_r = t_f = 6 \text{ ns}$ )**

Characteristics	Symbol	Test Condition	$T_a = 25^\circ\text{C}$			$T_a = -40 \sim 85^\circ\text{C}$		Unit
			$V_{CC}$ (V)	Min	Typ.	Max	Min	Max
Output transition time	$t_{TLH}$ $t_{THL}$	—	2.0	—	25	75	—	95
			4.5	—	7	15	—	19
			6.0	—	6	13	—	16
Propagation delay time (CK-Q)	$t_{pLH}$ $t_{pHL}$	—	2.0	—	54	145	—	180
			4.5	—	18	29	—	36
			6.0	—	15	25	—	31
Propagation delay time ( $\overline{\text{CLR}}$ -Q)	$t_{pLH}$ $t_{pHL}$	—	2.0	—	60	160	—	200
			4.5	—	20	32	—	40
			6.0	—	17	27	—	34
Maximum clock frequency	$f_{\text{max}}$	—	2.0	6	18	—	5	—
			4.5	30	56	—	24	—
			6.0	35	66	—	28	—
Input capacitance	$C_{IN}$	—	—	—	5	10	—	10
Power dissipation capacitance	$C_{PD}$ (Note)	—	—	—	43	—	—	—

Note:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per flip flop)}$$

And the total  $C_{PD}$  when n pcs. of flip flop operate can be gained by the following equation:

$$C_{PD}(\text{total}) = 32 + 11 \cdot n$$

## Package Dimensions

DIP20-P-300-2.54A

Unit : mm

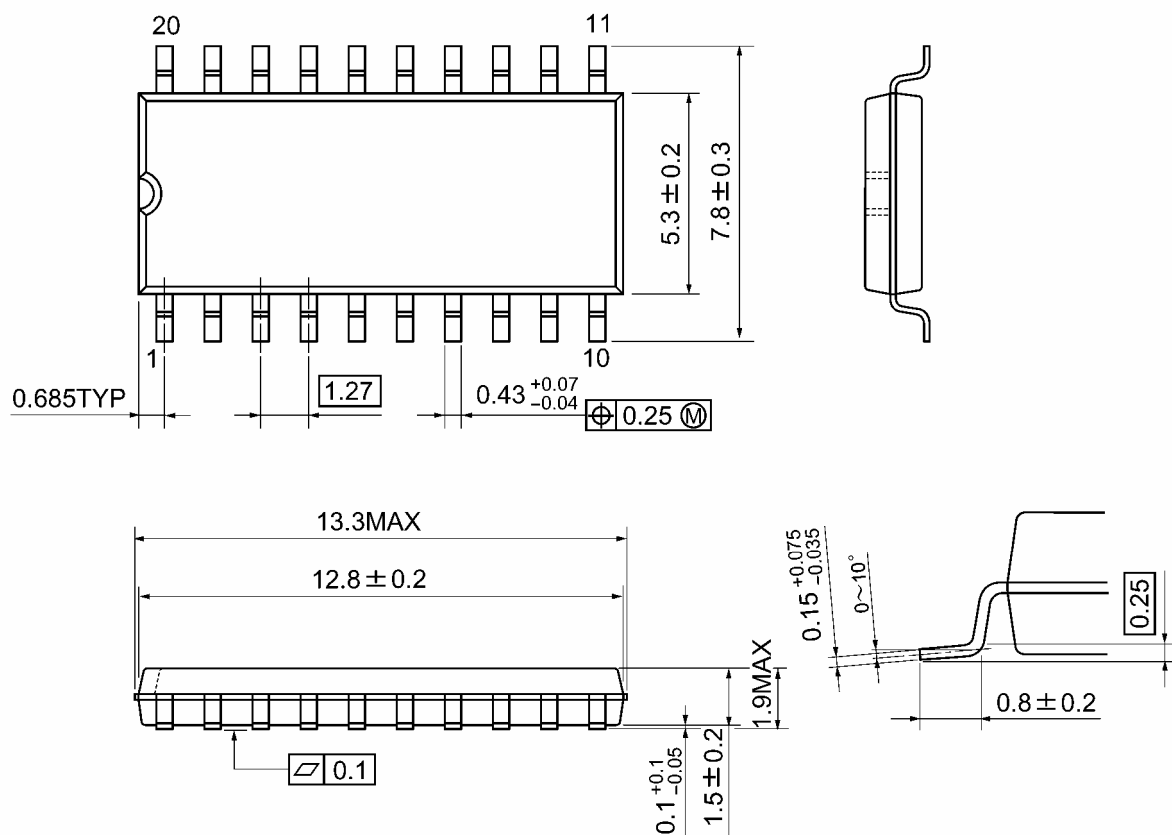


Weight: 1.30 g (typ.)

## Package Dimensions

SOP20-P-300-1.27A

Unit: mm

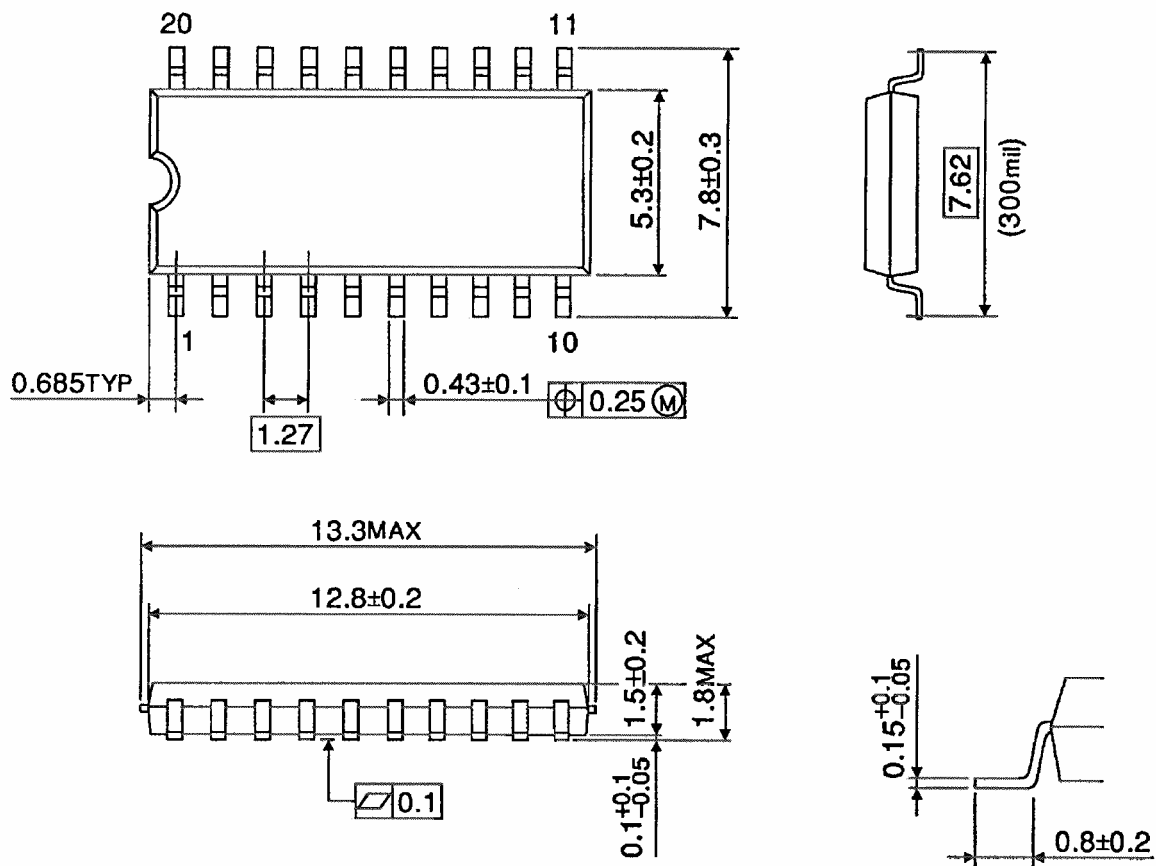


Weight: 0.22 g (typ.)

## Package Dimensions

SOP20-P-300-1.27

Unit : mm



Weight: 0.22 g (typ.)



**SOL20-P-300-1.27**

20

11

1

10

0.685TYP

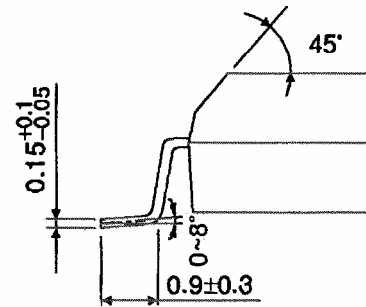
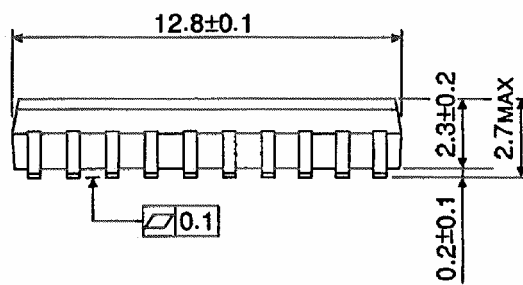
0.42±0.07

7.5±0.1

10.3±0.2

1.27

0.25 (M)



Weight: 0.46 g (typ.)

**Note: Lead (Pb)-Free Packages**

**DIP20-P-300-2.54A SOP20-P-300-1.27A**

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20070701-EN

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